



Your Reliable and Trustworthy Surplus Equipment Market Partner... Worldwide

UF3000EX Tri-Temp Wafer Probers (JAD-37883)

Make:	Accretech
Model:	UF3000EX
Quantity:	Up to 3 Available
Inspection:	Yes
Condition:	In Clean room, Fully working condition

Wafer Probers were docked to a Teradyne (Nextest) M2 and Agilent 4082 Test systems

Configuration 1:

- Configured for 8" or 12" Wafers 8" & 12"
- Chuck Type (Gold or Nickel) Nickel
- 3.5" 20GB Hard Disk
- 3.5" 2HD/DD
- Magneto-Optical Drive
- Single FOUP Port for 25 Wafers
- Manual Wafer Inspection Transfer Unit
- Dual Robotic Wafer Transport Arms
- Pre-Alignment Stage Unit
- Auto Needle Alignment
- Advanced Wafer Alignment Unit
- Alignment Camera E1-500
- Dual (X & Y) Heidenhain Scales
- Quad-Pod Z Stage
- Color LCD Control Panel with Touch Panel Switches
- Alarm Lamp Pole

Options:

- Hot or Cold Chucks Available (TSK or ERS)
- Wafer ID Options Available (TSK or Cognex)
- Needle Cleaning Option (Wafer type, Driven Disc type, Stage, Brush)
- Stage, Wafer
- Multi-Site Parallel Probing Option (3 to 256 Pins)
- GPIB Interface Option
- Ethernet Interface Option
- ACC (Automatic Probe card Changer)

- Image Processing Board C8200
- Bump Height Settings Option
- Group Index Option
- Multi-Pass Probe Option

Configuration 2 with AGV:

- Configured for 8" or 12" Wafers 8" & 12"
- Chuck Type (Gold or Nickel) Nickel
- 3.5" 20GB Hard Disk
- 3.5" 2HD/DD
- Magneto-Optical Drive
- Single FOUP Port for 25 Wafers
- Manual Wafer Inspection Transfer Unit
- Dual Robotic Wafer Transport Arms
- Pre-Alignment Stage Unit
- Auto Needle Alignment
- Advanced Wafer Alignment Unit
- Alignment Camera E1-500
- Dual (X & Y) Heidenhain Scales
- Quad-Pod Z Stage
- Color LCD Control Panel with Touch Panel Switches
- Alarm Lamp Pole

Options:

- Hot or Cold Chucks Available (TSK or ERS)
- Wafer ID Options Available (TSK or Cognex)
- Needle Cleaning Option (Wafer type, Driven Disc type, Stage, Brush)
- Stage, Wafer
- Multi-Site Parallel Probing Option (3 to 256 Pins)
- GPIB Interface Option
- Ethernet Interface Option
- Image Processing Board C8200
- Bump Height Settings Option
- Group Index Option
- Multi-Pass Probe Option
- Low noise chuck
- Fan Filter unit (mini-Environment)
- E84 I/F for AGV
- Probe mark Inspection
- Light Shield

